

ABSTRACT

RESIN COMPOSITION

There is disclosed a resin composition containing graft copolymer having at least one isocyanate group and 10,000 to 20,000 of number-average molecular weight, and low-molecular-weight polymer having at least one isocyanate group and 500 to 8,000 of number-average molecular weight is disclosed. This resin composition has tackiness at ordinary temperature, and long pot life. It can be used to reactive hot melt type adhesives or reactive hot melt type pressure-sensitive adhesives coating material which can be omitted hot press process.

This Sheet Has Been Replaced

